Octal buffer/line driver; inverting; 3-state

Rev. 1 — 6 November 2013

Product data sheet

1. General description

The 74AHC240-Q100 and 74AHCT240-Q100 are 8-bit inverting buffer/line drivers with 3-state outputs. These devices can be used as two 4-bit buffers or one 8-bit buffer. They feature two output enables (1OE and 2OE), each controlling four of the 3-state outputs. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Inputs are over voltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Balanced propagation delays
- All inputs have a Schmitt-trigger action
- Inputs accept voltages higher than V_{CC}
- For 74AHC240-Q100 only: operates with CMOS input levels
- For 74AHCT240-Q100 only: operates with TTL input levels
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - ◆ HBM JESD22-A114F exceeds 2000 V
- Multiple package options

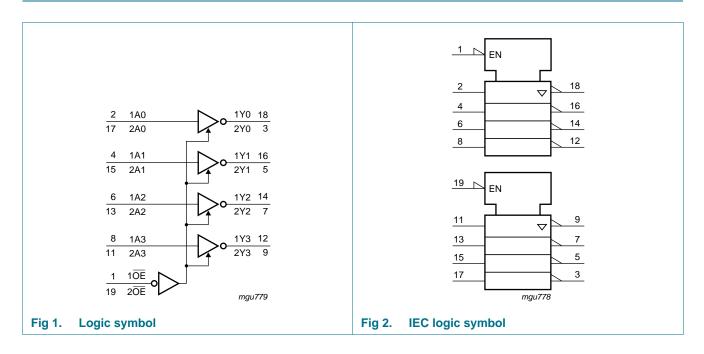


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3. Ordering information

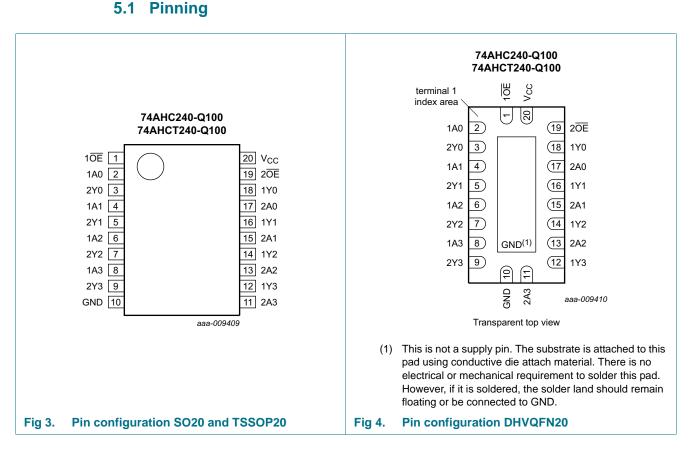
Table 1. Ordering in	nformation										
Type number	Package										
	Temperature range	Name	Description	Version							
74AHC240D-Q100	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1							
74AHCT240D-Q100			body width 7.5 mm								
74AHC240PW-Q100	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1							
74AHCT240PW-Q100			body width 4.4 mm								
74AHC240BQ-Q100	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced	SOT764-1							
74AHCT240BQ-Q100			very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm								

4. Functional diagram



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5. Pinning information



5.2 Pin description

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Table 2. Pin desc	cription	
Symbol	Pin	Description
1 0E	1	output enable input (active LOW)
2 <mark>0E</mark>	19	output enable input (active LOW)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2A0, 2A1, 2A2, 2A3	17, 15, 13, 11	data input
1Y0, 1Y1, 1Y2, 1Y3	18, 16, 14, 12	data output
2Y0, 2Y1, 2Y2, 2Y3	3, 5, 7, 9	data output
GND	10	ground (0 V)
V _{CC}	20	power supply

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6. Functional description

Table 3. Function table ^[1]		
Control	Input	Output
nOE	nAn	nYn
L	L	н
L	Н	L
Н	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	<u>[1]</u> –20	-	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$V_{\rm O}$ = -0.5 V to (V_{\rm CC} + 0.5 V)	-	±25	mA
I _{CC}	supply current		-	75	mA
I _{GND}	ground current		-75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO20 package: above 70 °C the value of P_{tot} derates linearly with 8.0 mW/K.

For TSSOP20 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN20 package: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5.	Recommended	operating	conditions
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	1 0					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
74AHC24	0-Q100					
V _{CC}	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 3.3 V \pm 0.3 V	-	-	100	ns/V
		V_{CC} = 5 V \pm 0.5 V	-	-	20	ns/V

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Table 5.	Recommended operating conditions continued								
Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
74AHCT2	40-Q100								
V _{CC}	supply voltage		4.5	5.0	5.5	V			
VI	input voltage		0	-	5.5	V			
Vo	output voltage		0	-	V _{CC}	V			
T _{amb}	ambient temperature		-40	+25	+125	°C			
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 5 V \pm 0.5 V	-	-	20	ns/V			

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

			-	25 °C			–40 °C to +85 °C		–40 °C to +125 °C	
/ _{IH}			Min	Тур	Max	Min	Max	Min	Max	
	0-Q100									
i	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
i	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
/ _{IL}	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
i	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
/ _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	I_{O} = -50 μ A; V_{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I_{O} = -50 μ A; V_{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		$I_{O} = -50 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.80	-	3.70	-	V
0L	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 50 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 50 \ \mu A; V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I_{O} = 8.0 mA; V_{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μA
-	OFF-state output current		-	-	±0.25	-	±2.5	-	±10.0	μA
СС	supply current		-	-	4.0	-	40	-	80	μA
•	input capacitance	$V_{I} = V_{CC}$ or GND	-	3	10	-	10	-	10	pF
0	output capacitance		-	4	-	-	-	-	-	pF

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Symbol	Parameter	Conditions		25 °C		–40 °C	to +85 °C	-40 °C t	to +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHCT	240-Q100									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	V_{I} = V_{IH} or $V_{\text{IL}};$ V_{CC} = 4.5 V								
	output voltage	I _O = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
lı	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μΑ
I _{OZ}	OFF-state output current		-	-	±0.25	-	±2.5	-	±10.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	4.0	-	40	-	80	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other pins at V_{CC} or GND; $I_O = 0 \text{ A}$; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance	$V_I = V_{CC} \text{ or } GND$	-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Octal buffer/line driver; inverting; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 7.

Symbol	Parameter	Conditions			25 °C		-4	0 °C to +′	25 °C	Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
74AHC2	40-Q100									
t _{pd} propagation	propagation delay	nAn to nYn; see <u>Figure 5</u>	[2]							
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 15 pF		-	3.9	7.5	1.0	8.6	10.8	ns
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 50 pF		-	5.8	11.0	1.0	12.5	15.6	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 15 pF		-	2.8	4.8	1.0	5.7	7.1	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 50 pF		-	4.2	7.3	1.0	8.5	10.6	ns
t _{en}	enable time	nOE to nYn; see <u>Figure 6</u>	[2]							
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 15 pF		-	4.4	10.0	1.0	12.0	19.4	ns
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 50 pF		-	5.8	13.5	1.0	15.5	19.4	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 15 pF		-	3.1	6.5	1.0	7.7	12.5	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 50 pF		-	4.1	8.5	1.0	10.0	12.5	ns
t _{dis}	disable time	nOE to nYn; see <u>Figure 6</u>	[2]							
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 15 pF		-	5.3	9.0	1.0	10.0	18.1	ns
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 50 pF		-	8.9	13.0	1.0	14.5	18.1	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 15 pF		-	3.9	5.8	1.0	6.5	8.1	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 50 pF		-	6.2	8.7	1.0	9.5	11.8	ns
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC} ; $C_L = 50 \text{ pF}$; $f_i = 1 \text{ MHz}$	[3]	-	9	-	-	-	-	pF

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Symbol	Parameter	Conditions			25 °C		-4	0 °C to +′	25 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
74AHCT	240-Q100									
t _{pd}	propagation delay	nAn to nYn; see <u>Figure 5</u>	[2]							
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 15 pF		-	3.0	5.8	1.0	6.8	8.5	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 50 pF		-	4.4	8.4	1.0	9.5	11.9	ns
t _{en} ena	enable time	nOE to nYn; see Figure 6	[2]							
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 15 pF		-	3.4	7.5	1.0	9.0	14.4	ns
		V_{CC} = 4.5 V to 5.5 V; C_L = 50 pF		-	4.5	9.5	1.0	11.5	14.4	ns
t _{dis}	disable time	nOE to nYn; see Figure 6	[2]							
		V_{CC} = 4.5 V to 5.5 V; C_L = 15 pF		-	3.9	6.1	1.0	6.7	8.3	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 50 pF		-	6.2	8.7	1.0	9.2	11.5	ns
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC} ; $C_L = 50 \text{ pF}$; $f_i = 1 \text{ MHz}$	<u>[3]</u>	-	9	-	-	-	-	pF

Dynamic characteristics ... continued Table 7.

Voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 7. O a se all'it a se a

[1] Typical values are measured at nominal supply voltage ($V_{CC} = 3.3$ V and $V_{CC} = 5.0$ V).

 $\label{eq:pd} [2] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}; t_{en} \text{ is the same as } t_{PZH} \text{ and } t_{PZL}; t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}.$

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 f_0 = output frequency in MHz;

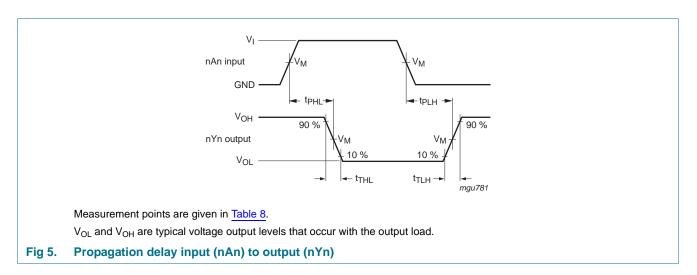
C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

11. Waveforms



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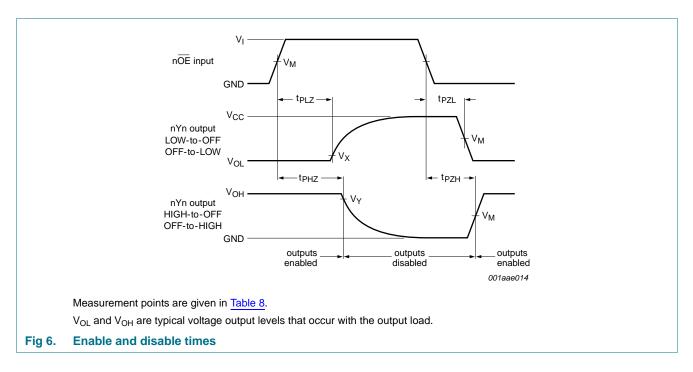


Table 8. Measurement points

Туре	Input	Output						
	V _M	V _M	V _X	V _Y				
74AHC240-Q100	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} – 0.3 V				
74AHCT240-Q100	1.5 V	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} – 0.3 V				

NXP Semiconductors

74AHC240-Q100; 74AHCT240-Q100

Octal buffer/line driver; inverting; 3-state

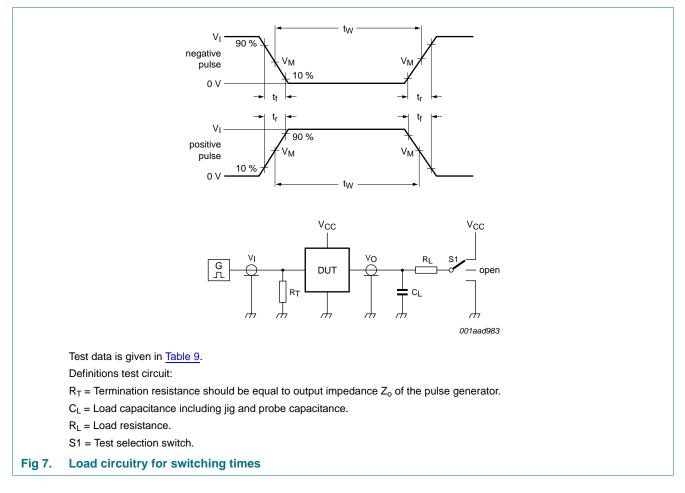


Table 9. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74AHC240-Q100	V _{CC}	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74AHCT240-Q100	3.0 V	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

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12. Package outline

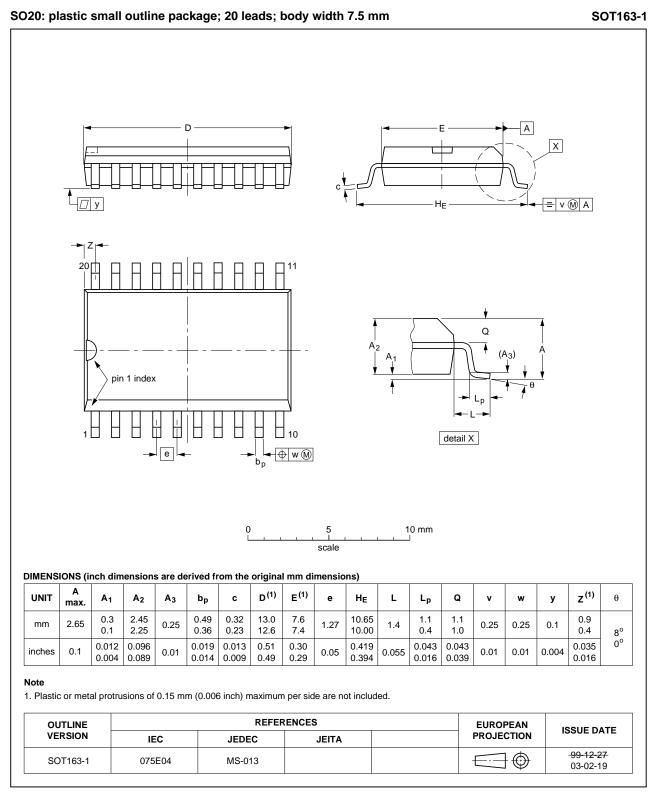


Fig 8. Package outline SOT163-1 (SO20)

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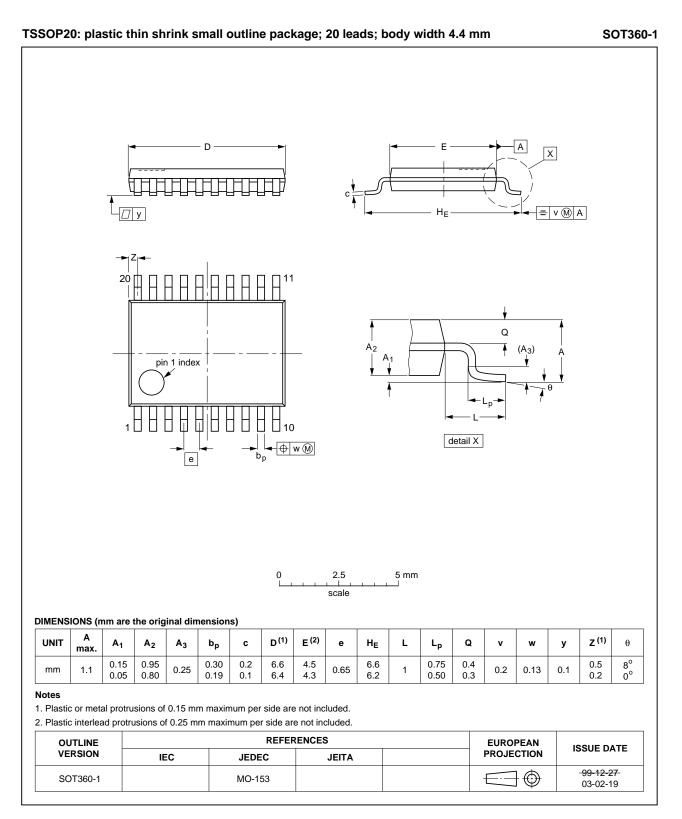
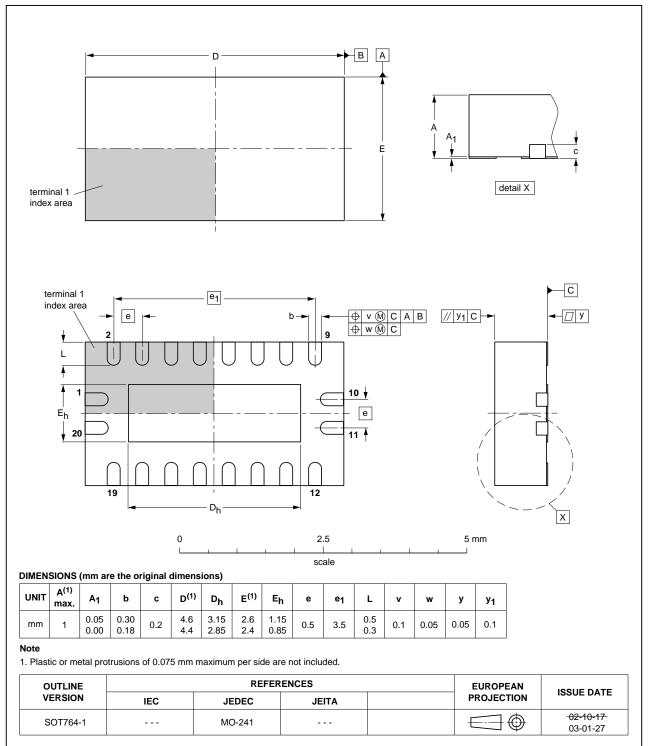


Fig 9. Package outline SOT360-1 (TSSOP20)

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Octal buffer/line driver; inverting; 3-state



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 10. Package outline SOT764-1 (DHVQFN20)

Octal buffer/line driver; inverting; 3-state

13. Abbreviations

Table 10.	Abbreviations	
Acronym	Description	
CDM	Charge Device Model	
CMOS	Complementary Metal Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
MIL	Military	
HBM	Human Body Model	
TTL	Transistor-Transistor Logic	

14. Revision history

Table 11. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT240_Q100 v.1	20131106	Product data sheet	-	-

Octal buffer/line driver; inverting; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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